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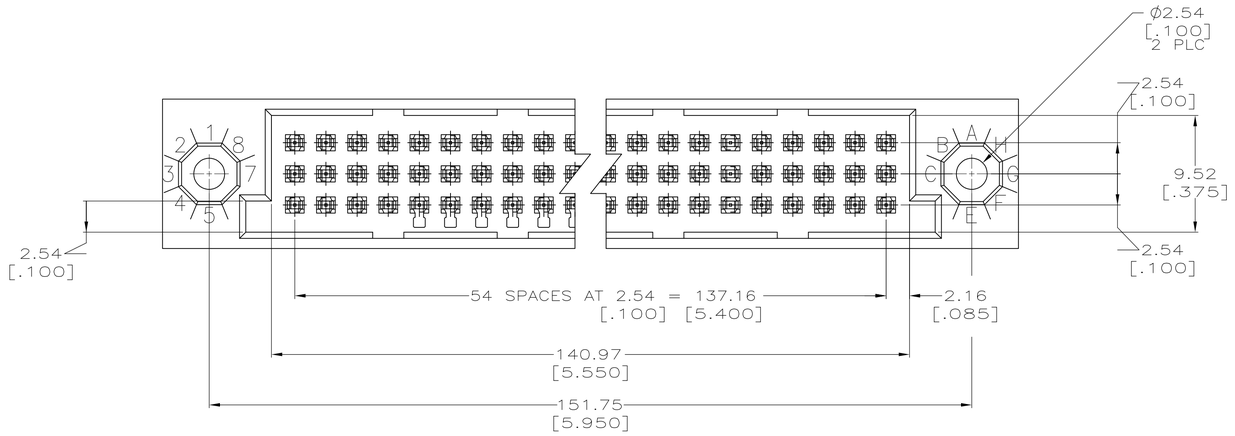
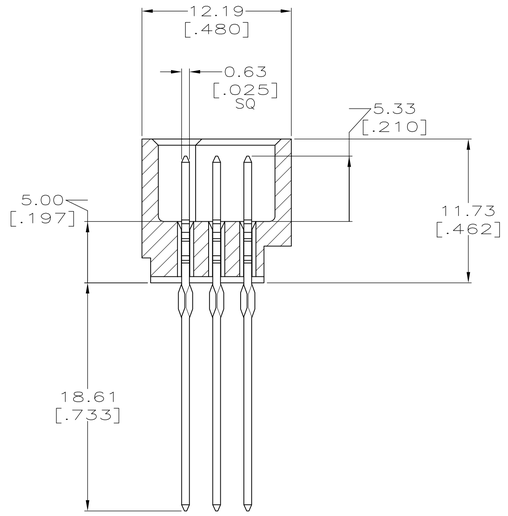
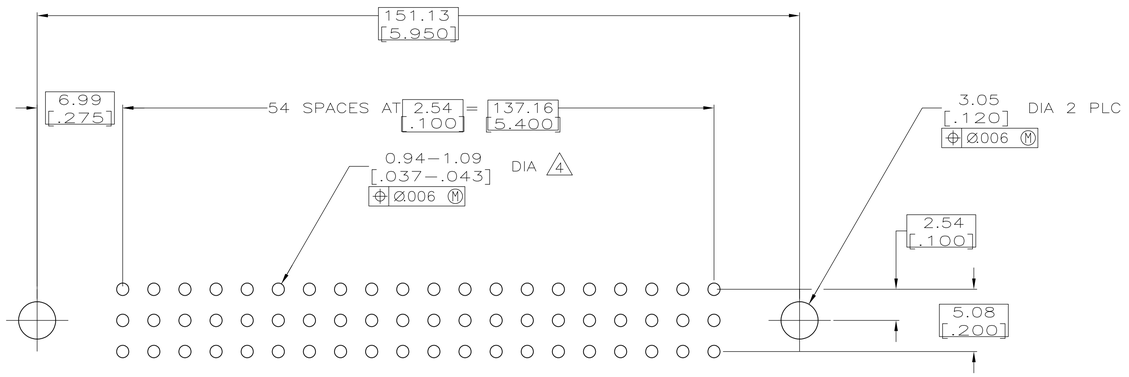
REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
	C	REVISED PER ECO-15-015252	13NOV15	BJ	FY





SECTION T–T

1. HOUSING MATERIAL: THERMOPLASTIC, BLACK.
2. CONTACT MATERIAL: PHOS. BRONZE.
3. FINISH:
   MATING AREA: MEETS THE PERFORMANCE REQUIREMENTS OF PRODUCT SPECIFICATION 108–9063; BASED ON TELCORDIA DR–1217–CORE APPLICATIONS IN UNCONTROLLED ENVIRONMENTS.
   SOLDER TAILS AREA: TIN–LEAD PLATED.
4. ACTION PIN POSTS REQUIRE 2.36[.093] MIN THICK P.C. BOARD. RECOMMENDED P.C. BOARD HOLES ARE 1.151 [.0453] DIA PLATED THRU WITH 0.025–0.076 [.001–.003] COPPER, WITH 0.0076 [.0003] MIN TIN–LEAD PLATING, FINISHED HOLE AFTER PLATING 0.94–1.09 [.037–.043] DIA.



RECOMMENDED P.C. BOARD LAYOUT

| NUMBER END | | | | |